

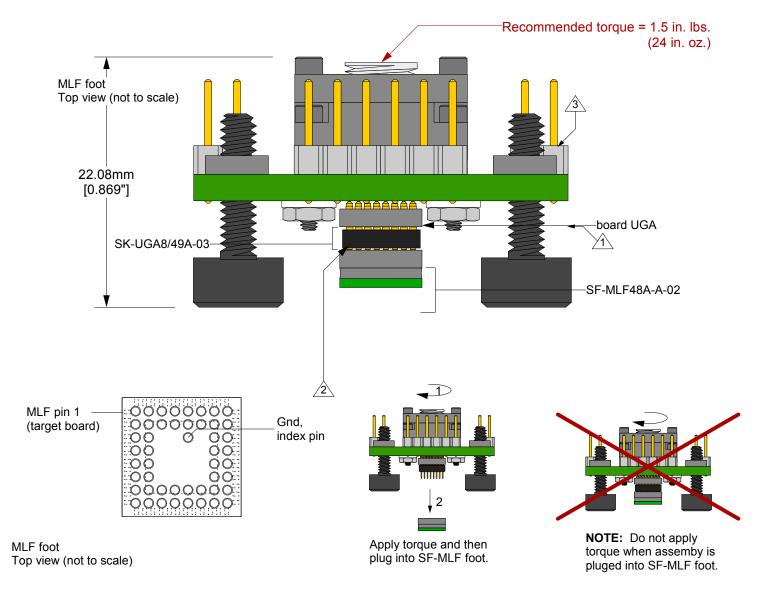
Description: Carrier Adaptor

48 position MLF ZIF socket to 48 position surface mountable MLF emulator foot with test probes. Pin assignment/ interconnect 1:1.

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 $\frac{Tolerances:}{\pm 0.03 mm} \ [\pm 0.001"], \ PCB \ perimeters \ \pm 0.13 mm \ [\pm 0.005"], \ PCB \ thicknesses \ \pm 0.18 mm \ [\pm 0.007"], \ pitches \ (from true \ position) \ \\ \pm 0.08 mm \ [\pm 0.003"], \ all \ other \ tolerances \ \pm 0.13 mm \ [\pm 0.005"] \ unless \ stated \ otherwise. \ Materials \ and \ specifications \ are \ subject \ to \ change \ without \ notice.$

CA-MLF48A-A-Z-T-01 Drawing	Status: Released	Scale	: 2:1	Rev: B
© 2004 IRONWOOD ELECTRONICS, INC. PO BOX 21151 ST. PAUL, MN 55121 Tele: (651) 452-8100 www.ironwoodelectronics.com	Drawing: H. Hansen		Date: 6/29/04	
	File: CA-MLF48A-A-Z-T-01 Dwg		Modified: 4/14/05	



Substrate: 2.34mm ±0.18mm [0.092" ±0.007"] FR4/G10 or equivalent high temp material. 17µm [1/2 oz.] Cu clad. SnPb plating.



Pins: material- Brass Alloy 360 1/2 hard; finish-0.25μm [10μ"] Au over 1.27μm [50μ"] Ni (min.).



Test points: material- Phosphor Bronze; plating-Sn over 1.27μm [50μ"] Ni. Gold flash on contact

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User Instructions:

- 1. Attach SF-MLF48A-A-02 foot to the target board.
- 2. Turn plastic thumb screws until head touches bottom of CA-MLF48A-A-Z-T-01 board.
- 3. Insert SK-UGA8/49A-03 into board UGA. Check orientation.
- 4. Remove socket lid and compression plate.
- 5. Insert MLF package into IC guide inside socket cavity.
- 6. Put compression plate and socket lid in place.
- 7. Hold socket assembly and apply recommended torque.
- 8. Carefully insert CA-MLF assembly into SF-MLF feet UGA. Check orientation.
- 9. Unscrew plastic thumb screws until they hit target board.

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